

## 8-BIT SERIAL-IN/PARALLEL-OUT SHIFT REGISTER

IN74LV164

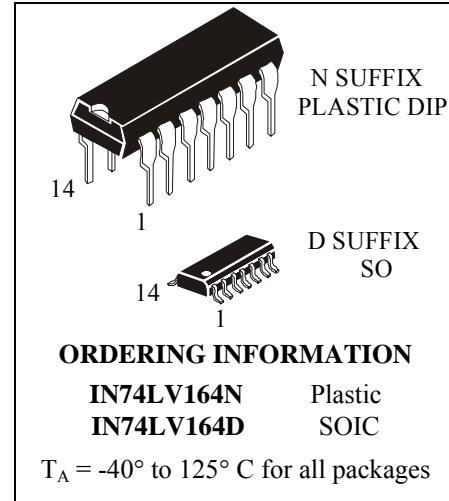
The IN74LV164 is a low-voltage Si-gate CMOS device and is pin and function compatible with the IN74HC/HCT164.

The IN74LV164 is an 8-bit edge-triggered shift register with serial data entry and an output from each of the eight stages. Data is entered serially through one of two inputs (DSA or DSB); either input can be used as an active HIGH enable for data entry through the other input. Both inputs must be connected together or an unused input must be tied HIGH.

Data shifts one place to the right on each LOW-to-HIGH transition of the clock (CP) input and enters into  $Q_0$ , which is the logical AND of the two data inputs (DSA, DSB) that existed one set-up time prior to the rising clock edge.

A LOW on the master reset (MR) input overrides all other inputs and clears the register asynchronously, forcing all outputs LOW.

- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 1.2 to 5.5 V
- Low Input Current: 1.0  $\mu$ A, 0.1  $\mu$ A at  $T = 25^\circ\text{C}$
- Output Current: 6 mA at  $V_{CC} = 3.0\text{ V}$ ; 12 mA at  $V_{CC} = 4.5\text{ V}$
- High Noise Immunity Characteristic of CMOS Devices



## ORDERING INFORMATION

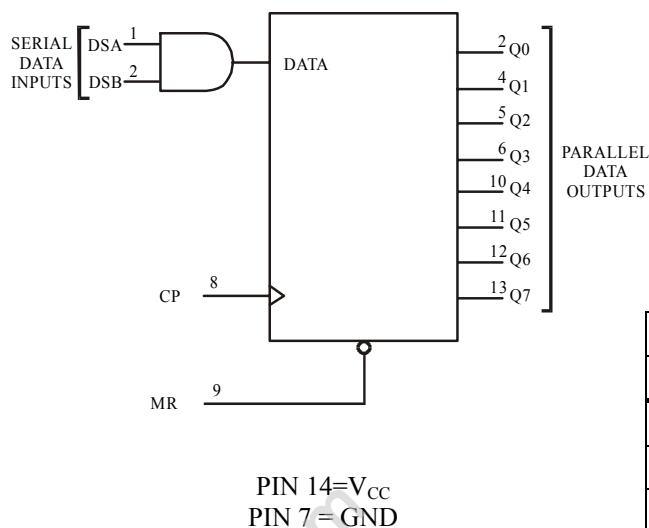
**IN74LV164N** Plastic  
**IN74LV164D** SOIC

$T_A = -40^\circ\text{ to }125^\circ\text{ C}$  for all packages

## PIN ASSIGNMENT

DSA	1	14	V <sub>CC</sub>
DSB	2	13	Q <sub>7</sub>
Q <sub>0</sub>	3	12	Q <sub>6</sub>
Q <sub>1</sub>	4	11	Q <sub>5</sub>
Q <sub>2</sub>	5	10	Q <sub>4</sub>
Q <sub>3</sub>	6	9	MR
GND	7	8	CP

## LOGIC DIAGRAM



## FUNCTION TABLE

Inputs				Outputs		
$\overline{\text{MR}}$	CP	DSA	DSB	Q <sub>0</sub>	Q <sub>1</sub> ... Q <sub>7</sub>	
L	X	X	X	L	L ... L	
H	/	L	L	L	Q <sub>0</sub> ... Q <sub>6</sub>	
H	/	L	H	L	Q <sub>0</sub> ... Q <sub>6</sub>	
H	/	H	L	L	Q <sub>0</sub> ... Q <sub>6</sub>	
H	/	H	H	H	Q <sub>0</sub> ... Q <sub>6</sub>	

H = high voltage level

L = low voltage level

X = don't care

**MAXIMUM RATINGS\***

<b>Symbol</b>	<b>Parameter</b>	<b>Value</b>	<b>Unit</b>
V <sub>CC</sub>	DC supply voltage	-0.5 to + 7.0	V
I <sub>IK</sub> * <sup>1</sup>	DC Input diode current	±20	mA
I <sub>OK</sub> * <sup>2</sup>	DC Output diode current	±50	mA
I <sub>O</sub> * <sup>3</sup>	DC Output source or sink current	±25	mA
I <sub>CC</sub>	V <sub>CC</sub> current	±50	mA
I <sub>GND</sub>	GND current	±50	mA
P <sub>D</sub>	Power dissipation per package: * <sup>4</sup> Plastic DIP SO	750 500	mW
T <sub>Stg</sub>	Storage Temperature	-65 to +150	°C
T <sub>L</sub>	Lead Temperature, 1.5 mm (Plastic DIP Package), 0.3 mm (SO Package) from Case for 4 Seconds	260	°C

\*Maximum Ratings are those values beyond which damage to the device may occur.

Functional operation should be restricted to the Recommended Operating Conditions.

\*<sup>1</sup> V<sub>I</sub> < -0.5 V or V<sub>I</sub> > V<sub>CC</sub> + 0.5 V.

\*<sup>2</sup> V<sub>O</sub> < -0.5 V or V<sub>O</sub> > V<sub>CC</sub> + 0.5 V.

\*<sup>3</sup> -0.5 V < V<sub>O</sub> < V<sub>CC</sub> + 0.5 V.

\*<sup>4</sup> Derating - Plastic DIP: - 12 mW/°C from 70° to 125°C

SO Package: : - 8 mW/°C from 70° to 125°C

**RECOMMENDED OPERATING CONDITIONS**

<b>Symbol</b>	<b>Parameter</b>	<b>Min</b>	<b>Max</b>	<b>Unit</b>	
V <sub>CC</sub>	DC Supply Voltage	1.2	5.5	V	
V <sub>I</sub>	Input Voltage	0	V <sub>CC</sub>	V	
V <sub>O</sub>	Output Voltage	0	V <sub>CC</sub>	V	
T <sub>A</sub>	Operating Temperature, All Package Types	-40	+125	°C	
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Time (Figure 1)	1.0 V ≤ V <sub>CC</sub> < 2.0 V 2.0 V ≤ V <sub>CC</sub> < 2.7 V 2.7 V ≤ V <sub>CC</sub> < 3.6 V 3.6 V ≤ V <sub>CC</sub> ≤ 5.5 V	0 0 0 0	500 200 100 50	ns

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V<sub>IN</sub> and V<sub>OUT</sub> should be constrained to the range GND≤(V<sub>IN</sub> or V<sub>OUT</sub>)≤V<sub>CC</sub>.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V<sub>CC</sub>). Unused outputs must be left open.

**DC ELECTRICAL CHARACTERISTICS** (Voltages Referenced to GND)

Symbol	Parameter	Test conditions	V <sub>CC</sub> V	Guaranteed Limit						Unit	
				25°C to -40°C		85°C		125°C			
				min	max	min	max	min	max		
V <sub>IH</sub>	HIGH level input voltage		1.2	0.9	-	0.9	-	0.9	-	V	
			2.0	1.4	-	1.4	-	1.4	-		
			2.7	2.0	-	2.0	-	2.0	-		
			3.0	2.0	-	2.0	-	2.0	-		
			3.6	2.0	-	2.0	-	2.0	-		
			4.5	3.15	-	3.15	-	3.15	-		
			5.5	3.85	-	3.85	-	3.85	-		
V <sub>IL</sub>	LOW level input voltage		1.2	-	0.3	-	0.3	-	0.3	V	
			2.0	-	0.6	-	0.6	-	0.6		
			2.7	-	0.8	-	0.8	-	0.8		
			3.0	-	0.8	-	0.8	-	0.8		
			3.6	-	0.8	-	0.8	-	0.8		
			4.5	-	1.35	-	1.35	-	1.35		
			5.5	-	1.65	-	1.65	-	1.65		
V <sub>OH</sub>	HIGH level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>O</sub> = -100 μA	1.2	1.05	-	1.0	-	1.0	-	V	
			2.0	1.85	-	1.8	-	1.8	-		
			2.7	2.55	-	2.5	-	2.5	-		
			3.0	2.85	-	2.8	-	2.8	-		
			3.6	3.45	-	3.4	-	3.4	-		
			4.5	4.35	-	4.3	-	4.3	-		
		V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>O</sub> = -6.0 mA	5.5	5.35	-	5.3	-	5.3	-		
			3.0	2.48	-	2.40	-	2.20	-	V	
			4.5	3.70	-	3.60	-	3.50	-	V	
V <sub>OL</sub>	LOW level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>O</sub> = 100 μA	1.2	-	0.15	-	0.2	-	0.2	V	
			2.0	-	0.15	-	0.2	-	0.2		
			2.7	-	0.15	-	0.2	-	0.2		
			3.0	-	0.15	-	0.2	-	0.2		
			3.6	-	0.15	-	0.2	-	0.2		
			4.5	-	0.15	-	0.2	-	0.2		
		V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>O</sub> = 6.0 mA	5.5	-	0.15	-	0.2	-	0.2		
			3.0	-	0.33	-	0.4	-	0.5	V	
			4.5	-	0.40	-	0.55	-	0.65	V	
I <sub>I</sub>	Input current	V <sub>I</sub> = V <sub>CC</sub> or 0 V	5.5	-	±0.1	-	±1.0	-	±1.0	μA	
I <sub>CC</sub>	Supply current	V <sub>I</sub> = V <sub>CC</sub> or 0 V I <sub>O</sub> = 0 μA	5.5	-	8.0	-	80	-	160	μA	
I <sub>CC1</sub>	Supply current	V <sub>I</sub> = V <sub>CC</sub> - 0.6 V	2.7 3.6	-	0.2	-	0.5	-	0.85	mA	

**AC ELECTRICAL CHARACTERISTICS** ( $C_L=50\text{ pF}$ ,  $t_r=t_f=2.5\text{ ns}$ ,  $R_L = 1\text{ k}\Omega$ )

Symbol	Parameter	Test conditions	V <sub>CC</sub> V	Guaranteed Limit						Unit	
				25°C to -40°C		85°C		125°C			
				min	max	min	max	min	max		
t <sub>PHL</sub> , t <sub>PLH</sub>	Propagation delay , CP to Qn	V <sub>I</sub> = 0 V or V <sub>1</sub> Figure 1 and 4	1.2	-	150	-	180	-	210	ns	
			2.0	-	30	-	39	-	49		
			2.7	-	23	-	29	-	36		
			3.0	-	18	-	23	-	29		
			4.5	-	15	-	19	-	24		
t <sub>PHL</sub>	Propagation delay , MR to Qn	V <sub>I</sub> = 0 V or V <sub>1</sub> Figure 1 and 4	1.2	-	150	-	180	-	210	ns	
			2.0	-	30	-	39	-	49		
			2.7	-	23	-	29	-	36		
			3.0	-	18	-	23	-	29		
			4.5	-	15	-	19	-	24		
t <sub>w</sub>	Pulse Width, CP or MR	V <sub>I</sub> = 0 V or V <sub>1</sub> Figure 1	1.2	100	-	130	-	160	-	ns	
			2.0	28	-	34	-	41	-		
			2.7	21	-	25	-	30	-		
			3.0	17	-	20	-	24	-		
			4.5	14	-	17	-	20	-		
t <sub>su</sub>	Setup Time, DSA or DSB to CP	V <sub>I</sub> = 0 V or V <sub>1</sub> Figure 3	1.2	60	-	80	-	100	-	ns	
			2.0	19	-	22	-	26	-		
			2.7	13	-	16	-	19	-		
			3.0	11	-	13	-	15	-		
			4.5	9	-	11	-	13	-		
t <sub>h</sub>	Hold Time, DSA or DSB to CP	V <sub>I</sub> = 0 V or V <sub>1</sub> Figure 3	1.2	50	-	50	-	50	-	ns	
			2.0	5	-	5	-	5	-		
			2.7	5	-	5	-	5	-		
			3.0	5	-	5	-	5	-		
			4.5	5	-	5	-	5	-		
t <sub>rec</sub>	Recovery Time, MR to CP	V <sub>I</sub> = 0 V or V <sub>1</sub> Figure 2	1.2	70	-	100	-	130	-	ns	
			2.0	15	-	19	-	24	-		
			2.7	11	-	14	-	18	-		
			3.0	9	-	11	-	14	-		
			4.5	8	-	10	-	12	-		
f <sub>max</sub>	Clock Frequency	V <sub>I</sub> = 0 V or V <sub>1</sub> Figure 1 and 4	1.2	-	2	-	1	-	1	MHz	
			2.0	-	16	-	14	-	12		
			2.7	-	22	-	19	-	16		
			3.0	-	27	-	24	-	20		
			4.5	-	32	-	27	-	24		
C <sub>I</sub>	Input capacitance		5.0	-	7.0	-	-	-	-	pF	
C <sub>PD</sub>	Power dissipation capacitance	V <sub>I</sub> = 0 V or V <sub>CC</sub>	5.5	-	80	-	-	-	-		

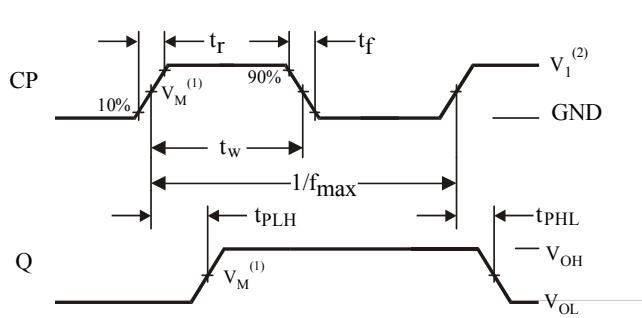


Figure 1. Switching Waveforms

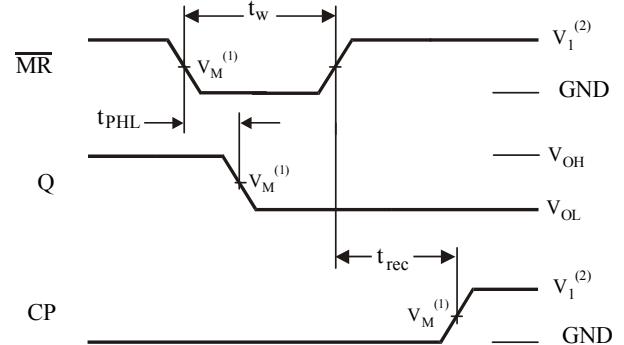


Figure 2. Switching Waveforms

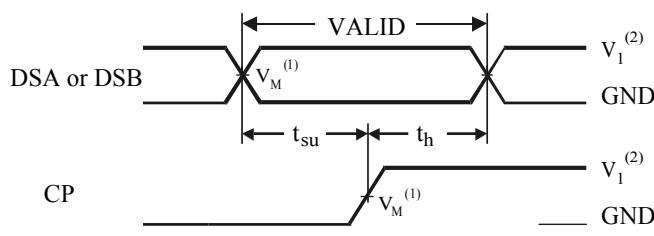


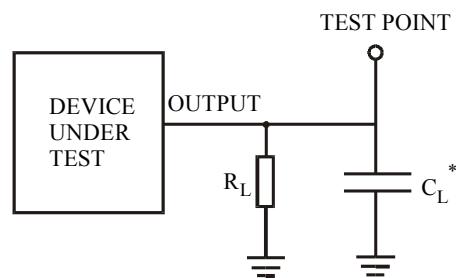
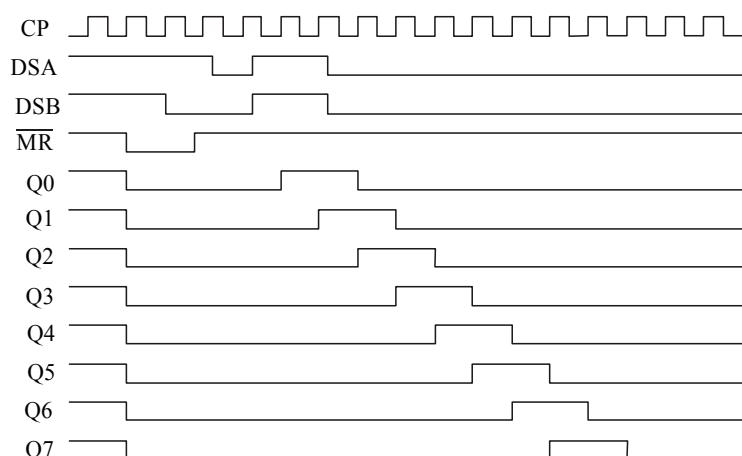
Figure 3. Switching Waveforms

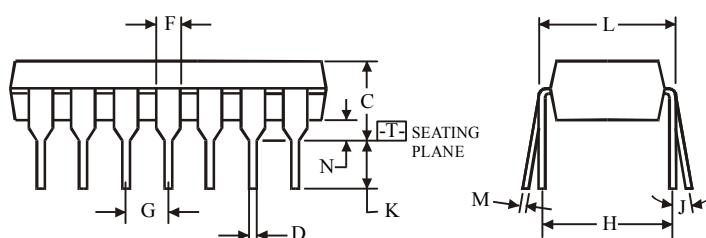
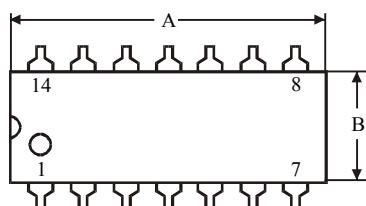
**Note:**

- (1)  $V_M = 1.5 \text{ V}$  at  $V_{CC} = 2.7 \text{ V}$   
 $V_M = 0.5 \cdot V_{CC}$  at  $V_{CC} = 1.2 \text{ V}, 2.0 \text{ V}, 3.0 \text{ V}, 4.5 \text{ V}$
- (2)  $V_1 = V_{CC}$  at  $V_{CC} = 1.2 \text{ V}, 2.0 \text{ V}, 2.7 \text{ V}, 4.5 \text{ V}$   
 $V_1 = 2.7 \text{ V}$  at  $V_{CC} = 3.0 \text{ V}$

\* Includes all probe and jig capacitance

Figure 4. Test Circuit

**TIMING DIAGRAM**

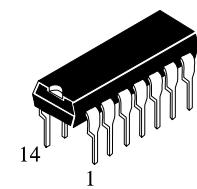
**N SUFFIX PLASTIC DIP  
(MS - 001AA)**


$\oplus 0.25$  (0.010)  $\ominus$  T

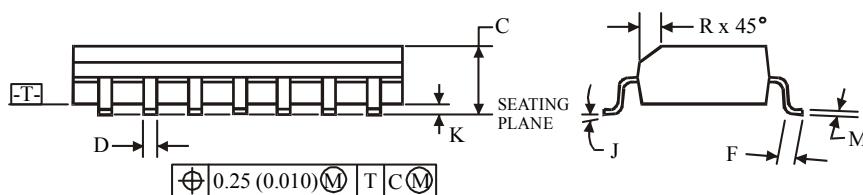
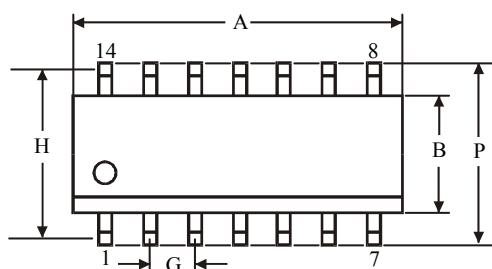
**NOTES:**

- Dimensions "A", "B" do not include mold flash or protrusions.

Maximum mold flash or protrusions 0.25 mm (0.010) per side.



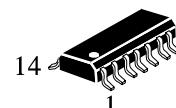
Symbol	Dimension, mm	
	MIN	MAX
A	18.67	19.69
B	6.1	7.11
C		5.33
D	0.36	0.56
F	1.14	1.78
G		2.54
H		7.62
J	0°	10°
K	2.92	3.81
L	7.62	8.26
M	0.2	0.36
N	0.38	

**D SUFFIX SOIC  
(MS - 012AB)**


$\oplus 0.25$  (0.010)  $\ominus$  T  $\ominus$  C  $\ominus$  M

**NOTES:**

- Dimensions A and B do not include mold flash or protrusion.
- Maximum mold flash or protrusion 0.15 mm (0.006) per side for A; for B - 0.25 mm (0.010) per side.



Symbol	Dimension, mm	
	MIN	MAX
A	8.55	8.75
B	3.8	4
C	1.35	1.75
D	0.33	0.51
F	0.4	1.27
G		1.27
H		5.27
J	0°	8°
K	0.1	0.25
M	0.19	0.25
P	5.8	6.2
R	0.25	0.5